

# PNZ108CL (PN108CL)

## Silicon planar type

For optical control systems

### ■ Features

- High sensitivity:  $I_L = 3.5 \text{ mA (min.)}$
- Narrow directivity characteristics for effective use of light input
- Fast response:  $t_r = 5 \text{ } \mu\text{s (typ.)}$
- Signal mixing capability using base pin
- Small size (low in height) package

### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

| Parameter                             | Symbol    | Rating      | Unit             |
|---------------------------------------|-----------|-------------|------------------|
| Collector-emitter voltage (Base open) | $V_{CEO}$ | 20          | V                |
| Collector-base voltage (Emitter open) | $V_{CBO}$ | 30          | V                |
| Emitter-collector voltage (Base open) | $V_{ECO}$ | 3           | V                |
| Emitter-base voltage (Collector open) | $V_{EBO}$ | 5           | V                |
| Collector current                     | $I_C$     | 20          | mA               |
| Collector power dissipation           | $P_C$     | 100         | mW               |
| Operating ambient temperature         | $T_{opr}$ | -25 to +85  | $^\circ\text{C}$ |
| Storage temperature                   | $T_{stg}$ | -30 to +100 | $^\circ\text{C}$ |

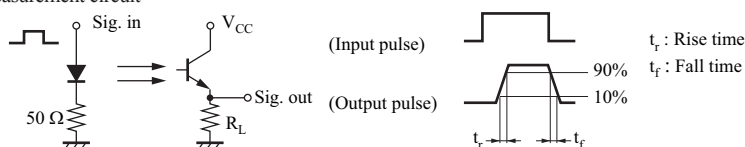
### ■ Electrical-Optical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

| Parameter                                    | Symbol         | Conditions   | Min | Typ  | Max | Unit          |
|--|----------------|--|-----|------|-----|---------------|
| Photocurrent *1                              | $I_L$          | $V_{CE} = 10 \text{ V, } L = 500 \text{ lx}$                             | 3.5 |      |     | mA            |
| Collector-emitter cutoff current (Base open) | $I_{CEO}$      | $V_{CE} = 10 \text{ V}$  |     | 0.05 | 2.0 | $\mu\text{A}$ |
| Collector-emitter saturation voltage *1      | $V_{CE(sat)}$  | $I_L = 1 \text{ mA, } L = 1000 \text{ lx}$                               |     | 0.3  | 0.6 | V             |
| Peak sensitivity wavelength                  | $\lambda_{PD}$ | $V_{CE} = 10 \text{ V}$  |     | 900  |     | nm            |
| Half-power angle                             | $\theta$       | The angle when the photocurrent is halved                                |     | 80   |     | $^\circ$      |
| Rise time *2                                 | $t_r$          | $V_{CC} = 10 \text{ V, } I_L = 5 \text{ mA, } R_L = 100 \text{ } \Omega$ |     | 5    |     | $\mu\text{s}$ |
| Fall time *2                                 | $t_f$          |  |     | 6    |     | $\mu\text{s}$ |

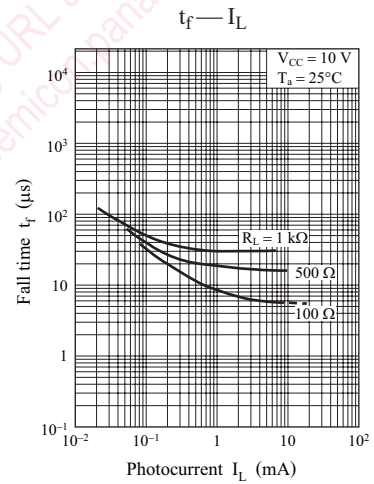
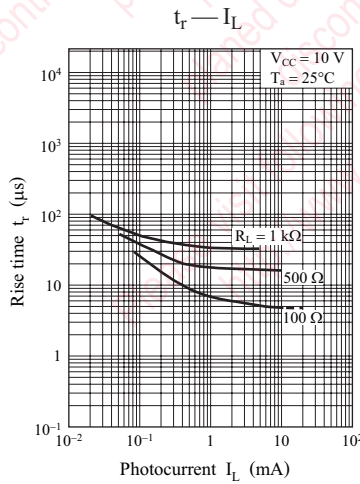
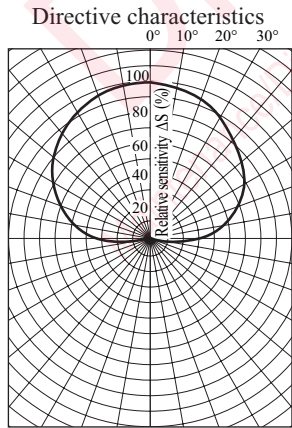
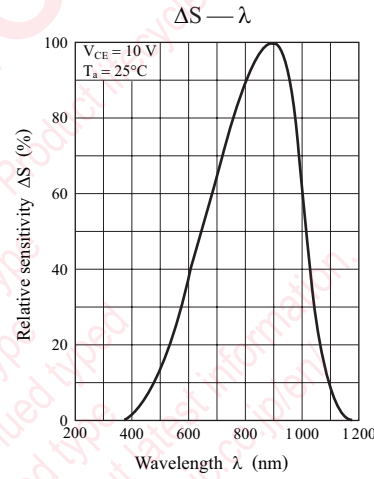
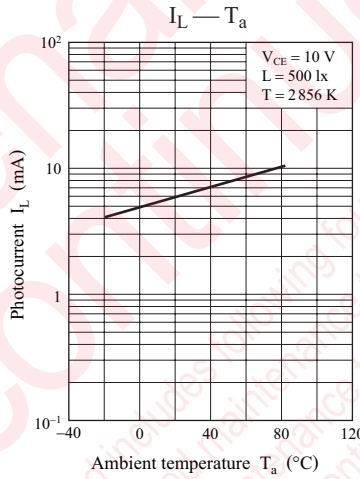
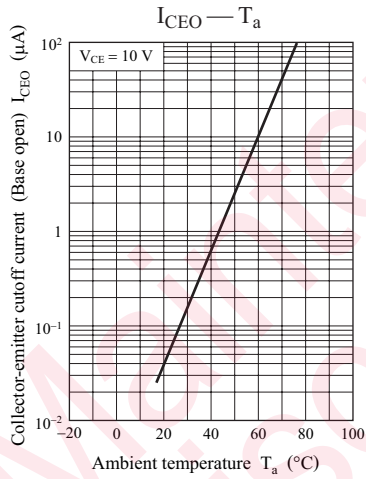
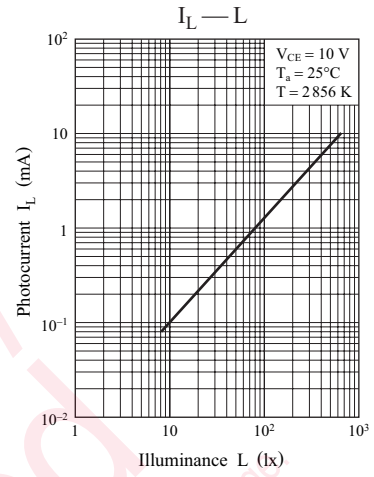
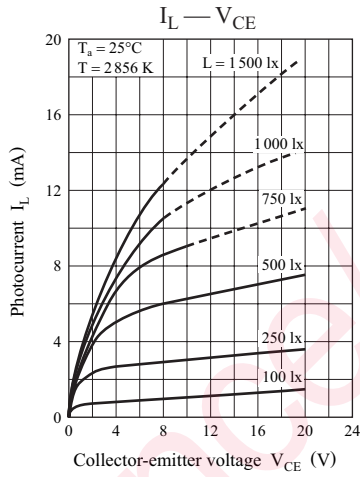
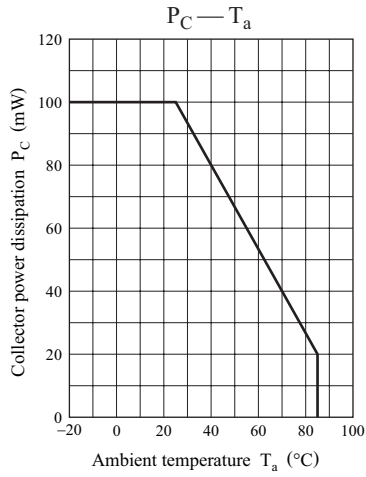
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. Spectral sensitivity characteristics: Sensitivity for wave length over 400 nm maximum sensitivity ratio is 100%.
3. This device is designed by disregarding radiation.
4. \*1:Source: Tungsten lamp (color temperature 2 856K)

\*2: Switching time measurement circuit

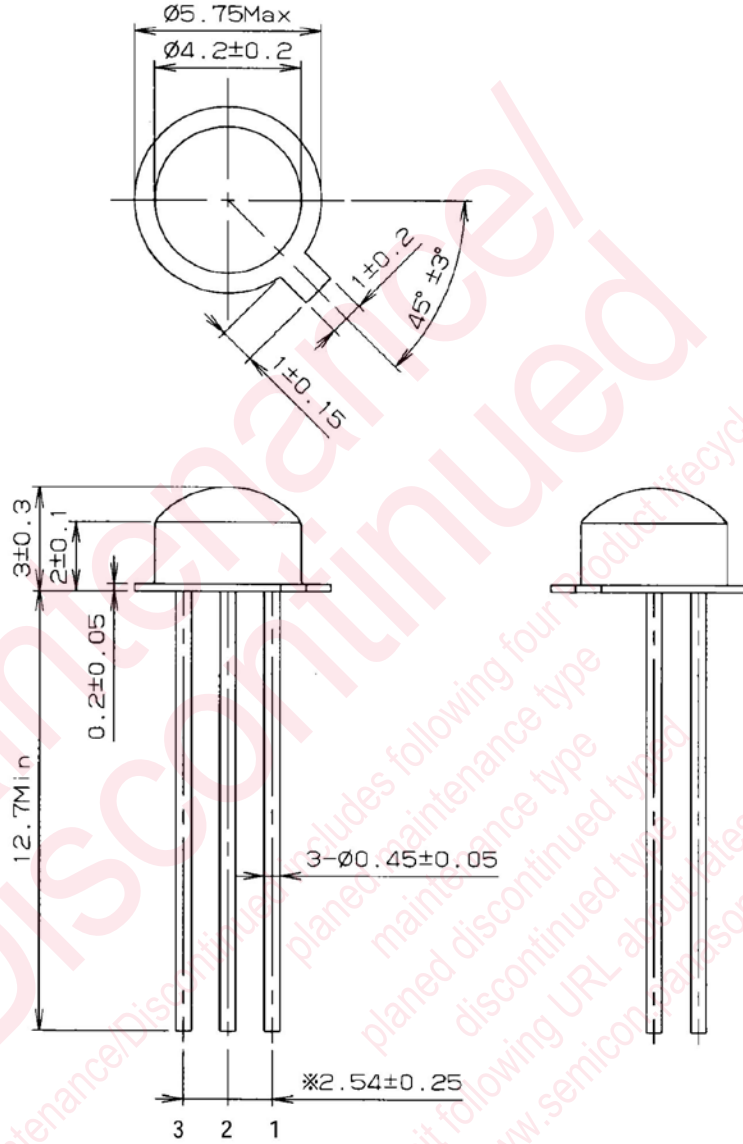


Note) The part number in the parenthesis shows conventional part number.



■ Package (Unit: mm)

MPDLTN3S0001



- Pin name
- 1: Emitter
- 2: Base
- 3: Collector

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